

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Ka Wai Eric Cheng</td><td>03/07/2008</td></tr><tr><td>Yuen Wah Wong</td><td>03/07/2008</td></tr><tr><td>Wei Tai Wu</td><td>03/07/2008</td></tr><tr><td>Kai Ding</td><td>03/07/2008</td></tr><tr><td>Yiu Lun Ho</td><td>03/07/2008</td></tr><tr><td>Tsz Kong Cheung</td><td>03/07/2008</td></tr><tr><td>Chi Keong Cheong</td><td>03/07/2008</td></tr></tbody></table>	Name	Execution Date	Ka Wai Eric Cheng	03/07/2008	Yuen Wah Wong	03/07/2008	Wei Tai Wu	03/07/2008	Kai Ding	03/07/2008	Yiu Lun Ho	03/07/2008	Tsz Kong Cheung	03/07/2008	Chi Keong Cheong	03/07/2008	
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RECEIVING PARTY DATA																	
Name:	The Hong Kong Polytechnic University																
Street Address:	Hung Hom																
City:	Kowloon																
State/Country:	HONG KONG																
PROPERTY NUMBERS Total: 1																	
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12039592</td></tr></tbody></table>	Property Type	Number	Application Number:	12039592													
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Application Number:	12039592																
CORRESPONDENCE DATA																	
Fax Number:	(978)268-8715																
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>																	
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ATTORNEY DOCKET NUMBER:	WKG04-045-US																

OP \$40.00 12039592

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PATENT
REEL: 020792 FRAME: 0570

NAME OF SUBMITTER:

Frank R. Cozzi

Total Attachments: 3

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ASSIGNMENT

WHEREAS, Ka Wai Eric CHENG, Yuen Wah WONG, Wei Tai WU, Kai DING, Yiu Lun HO, Tsz Kong CHEUNG and Chi Keong CHEONG referred to as ASSIGNORS, have invented a certain invention entitled Polymer-Bonded Magnetic Materials, filed on February 28, 2008 and assigned Application Serial No. 12/039,592 and

WHEREAS, The Hong Kong Polytechnic University, an academic institution of Hong Kong, SAR, with a principal place of business, at Hung Hom, Kowloon, Hong Kong, SAR, P.R. CHINA hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in, to and under said invention and the United States Letters Patent to be obtained therefore.

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN:

Be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, the ASSIGNORS hereby sell, assign and transfer to ASSIGNEE the full and exclusive right, title and interest to said invention and all Letters Patent of the United States to be obtained therefor on said applications or any non-provisional, continuation, division, renewal, substitute or reissue thereof, as well as any and all provisional applications from which said applications claim priority for the full term or terms for which the same may be granted.

ASSIGNORS also assign all of its rights, title, and interest in and to said invention, the worldwide right to file applications for Letters Patent for said invention, and all applications for Letters Patent for said invention, which may evolve therefrom, including the right to claim International Convention priority.

ASSIGNORS hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

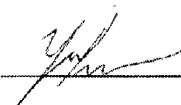
ASSIGNORS further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said applications, said invention and said Letters Patent as may be known and accessible to ASSIGNORS, and ASSIGNORS will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said applications, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof. An attorney of record is authorized and requested by the execution of this assignment to insert into this assignment the filing date and serial number of said application when officially known, and correct any minor typographical errors.

DATE 7 Mar 2008


Ka Wai Eric CHENG

WITNESSED

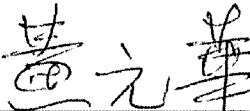
DATE 7 March 2008


Yuen Wah WONG

DATE 7/March/2008

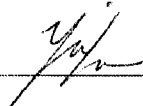

Chi Keong CHEONG

DATE 7 March 2008


Yuen Wah WONG

WITNESSED

DATE 7 March 2008



DATE 7/March/2008

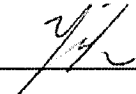
Ding Kai

DATE 7/03/2008

Wu Wei Tai
Wei Tai WU

WITNESSED

DATE 7 March 2008



DATE 7/March/2008

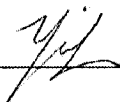
Ding Kai

DATE 7/March/2008

Ding Kai
Kai DING

WITNESSED

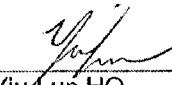
DATE 7 March 2008



DATE 7/March/2008

Lin Jiongkang

DATE 7 March 2008


Yiu Lun HO

WITNESSED

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Ding Kai

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Lin Jiongkang

DATE 7 March 2008

Kong
Tsz Kong CHEUNG

WITNESSED

DATE 07 March 2008

[Signature]

DATE 7/March/2008

Ding kis

DATE 7/March/2008

Chi Keong
Chi Keong CHEONG

WITNESSED

DATE 7 March 2008

[Signature]

DATE 7/ March /2008

Ding kis